



In re Application of:

Docket No.: 02922.000070 (2922.0070)

Hiromi HONDA, et al.

Application No.: 10/022,503

Examiner: C. Lam

Filed: December 20, 2001

Group Art Unit: 1775

For: PRINTED WIRING BOARD AND
ELECTRONIC APPARATUS

Date: December 30, 2002

Commissioner for Patents
Washington, D.C. 20231

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Sir:

Transmitted herewith is an Amendment in the above-identified application.

No additional fee is required.

The fee has been calculated as shown below:

CLAIMS AS AMENDED						
	CLAIMS REMAINING AFTER AMENDMENT		HIGHEST NO. PREVIOUSLY PAID FOR	PRESENT EXTRA	RATE	ADDITIONAL FEE
TOTAL CLAIMS	10	MINUS	20	= 0	x \$9 \$18	\$ -0-
INDEP. CLAIMS	1	MINUS	3	= 0	x \$42 \$84	\$ -0-
Fee for Multiple Dependent claims \$140°/\$280						
TOTAL ADDITIONAL FEE FOR THIS AMENDMENT---						\$ -0-

°Verified Statement claiming small entity status is enclosed, if not filed previously.

A check in the amount of \$____ is enclosed.

Charge \$____ to Deposit Account No. 06-1205. A duplicate copy of this sheet is enclosed.

- Any prior general authorization to charge an issue fee under 37 C.F.R. 1.18 to Deposit Account No. 06-1205 is hereby revoked. The Commissioner is hereby authorized to charge any additional fees under 37 C.F.R. 1.16 and 1.17 which may be required during the entire pendency of this application, or to credit any overpayment, to Deposit Account No. 06-1205. A duplicate copy of this paper is enclosed.
- A check in the amount of \$ _____ to cover the fee for a _____ month extension is enclosed.
- A check in the amount of \$ _____ to cover the Information Disclosure Statement fee is enclosed.
- Applicants' undersigned attorney may be reached in our Washington, D.C. office by telephone at (202) 530-1010. All correspondence should continue to be directed to our address given below.

Respectfully submitted,



Attorney for Applicants
Michael E. Kondoudis
Registration No. 42,758

FITZPATRICK, CELLA, HARPER & SCINTO
30 Rockefeller Plaza
New York, New York 10112-3801
Facsimile: (212) 218-2200
MEK:cmv

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PATENT & TRADEMARK OFFICE

02922.000070 (2922.0070)

PATENT APPLICATION

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

In re Application of:)
Hiromi HONDA, et al.) Examiner: C. Lam
Application No.: 10/022,503) Group Art Unit: 1775
Filed: December 20, 2001)
For: PRINTED WIRING BOARD AND) December 30, 2002
ELECTRONIC APPARATUS : #8/A
Kee
1-603

Commissioner for Patents
Washington, D.C. 20231

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AMENDMENT

Sir:

In response to the Office Action dated September 30, 2002, please amend the above-identified application as follows:

IN THE SPECIFICATION:

Please substitute the paragraph starting at page 1, line 8 and ending at line 15, with the following paragraph. A marked-up copy of this paragraph, showing the changes made thereto, is attached.

--This invention relates to a printed wiring board which is capable of preventing the occurrence of lift-off and land peeling at soldered portions when a component to be mounted on the printed wiring board (hereinafter referred to as the "inserted component" is

PL